July 2008

# FDW2501NZ

AIRCHIL

# Dual N-Channel 2.5V Specified PowerTrench<sup>®</sup> MOSFET

### **General Description**

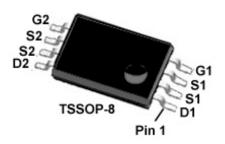
This N-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

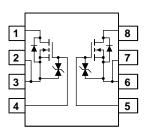
## Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

## Features

- 5.5 A, 20 V.  $R_{DS(ON)} = 18 \text{ m}\Omega @ V_{GS} = 4.5 V$  $R_{DS(ON)} = 25 \text{ m}\Omega @ V_{GS} = 2.5 V$
- Extended  $V_{GSS}$  range (±12V) for battery applications
- ESD protection diode (note 3)
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- Low profile TSSOP-8 package





# Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		20	V
V <sub>GSS</sub>	Gate-Source Voltage		±12	V
I <sub>D</sub>	Drain Current – Continuous	(Note 1a)	5.5	A
	– Pulsed		30	
PD	Power Dissipation	(Note 1a)	1.0	W
		(Note 1b)	0.6	
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	100	°C/W
		(Note 1b)	125	

# **Package Marking and Ordering Information**

Device Marking	Device	Reel Size	Tape width	Quantity
2501NZ	FDW2501NZ	13"	12mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
				-71-		
	acteristics			1	1	.,
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		14		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 16 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
	Gate-Body Leakage, Forward	$V_{GS} = 12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			10	μA
	Gate-Body Leakage, Reverse	$V_{GS} = -12 \text{ V},  V_{DS} = 0 \text{ V}$			-10	μA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.6	1.0	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-3		mV/°0
R <sub>DS(on)</sub>	Static Drain–Source	$V_{GS} = 4.5 \text{ V}, \qquad I_D = 5.5 \text{ A}$		14	18	mΩ
	On–Resistance	$V_{GS} = 2.5 V$ , $I_D = 5 A$		19	25	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C}$		19	29	
D(on)	On–State Drain Current	$V_{GS} = 4.5 V, V_{DS} = 5 V$	30			A
<b>g</b> fs	Forward Transconductance	$V_{DS} = 5 V$ , $I_D = 5.5 A$		30		S
Dynamio	Characteristics			1	1	
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 \text{ V}, \qquad V_{GS} = 0 \text{ V},$		1286		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		305		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			161		pF
Switchir	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = 10 V$ , $I_D = 1 A$ ,		10	20	ns
tr	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \ \Omega$		14	25	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			25	40	ns
t <sub>f</sub>	Turn–Off Fall Time			8	16	ns
Qg	Total Gate Charge	$V_{DS} = 10 V$ , $I_D = 5.5 A$ ,		12	17	nC
Q <sub>gs</sub>	Gate–Source Charge	$V_{GS} = 4.5 V$		2.6		nC
Q <sub>gd</sub>	Gate–Drain Charge			3		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source				1.0	А
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_{S} = 1.0 A$ (Note 2)		0.7	1.2	V

1. R<sub>6JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

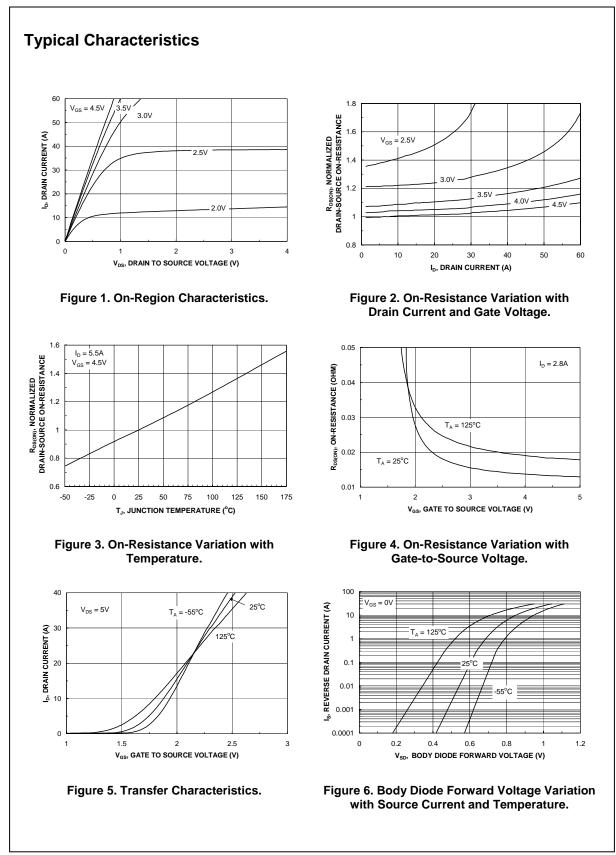
a)  $\rm R_{\theta JA}$  is 100°C/W (steady state) when mounted on a 1 inch² copper pad on FR-4.

b)  $R_{\theta JA}$  is 125°C/W (steady state) when mounted on a minimum copper pad on FR-4.

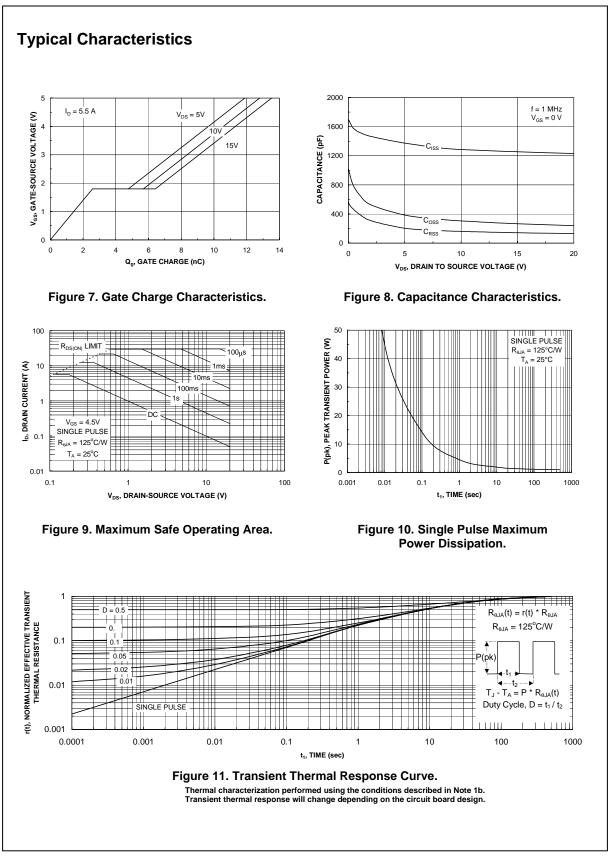
2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

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